

Sponsors of Tomorrow.™





Dadi Perlmutter

Executive Vice President Intel Architecture Group







Renee J. James
Senior Vice President
General Manager, Software and Services Group



Delivering on the Intel Compute Continuum

Servers/Cloud



Desktops **Laptops Netbooks** Personal **Devices**

Smartphones **Smart TVs**

IVI Embedded























Application Distribution Channels

Developer Programs and Support

Operating Environment

Intel® Architecture



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Desktops **Laptops Netbooks** Personal **Devices**

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IVI Embedded























Application Distribution Channels

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Operating Environment

Intel® Architecture



MeeGo*

Bringing a Unified Operating Environment to Intel® Atom™-based Devices



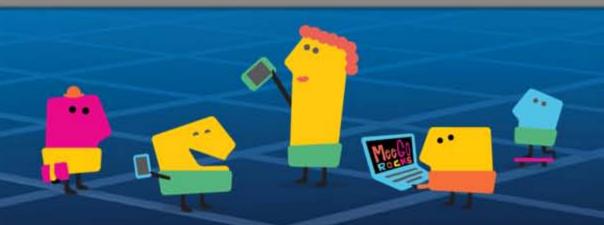
Single Unified Operating Environment



Platforms based on Intel® Atom™ processors

"MeeGo lowers complexity for Asus targeting multiple market segments like netbooks and tablets."

—Samson Hu Vice President, ASUS System Business Group Manager, Eee System Business Group





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Application Distribution Channels

Developer Programs and Support

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Intel® Architecture



Intel® AppUp™ Store Partnership



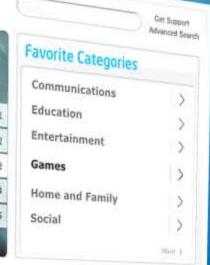
Store

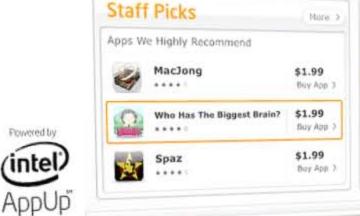
My Apps

Powered by

(intel













An Explosion of Internet Growth

Today

2015

More Users

25% of the World is Connected ¹



>1 Billion Additional Users to the Cloud²

More Devices

~80% of those devices are Computers & Phones³



Connected Devices
>10 Billion Globally³

More Content 2.5B Photos on Facebook⁴ 30B Videos Viewed/Mos⁵



8X Network, 16X Storage & 20x Compute Capacity Needed⁶

Exponential Growth Driving Need for A Billion Virtual Server Cloud⁷



The question then is how do we keep up with this deluge of data and build a better data center?



Foundation of a Data Center

Secure

Personal and company data protected at rest and in flight

Simplified

Flexible infrastructure with unified network

Efficient

World class component, platform and data center energy efficiency

Open

Multi-vendor innovation with compatibility of solutions

Data Center Roadmap Driven by Intel's Tick-Tock Cadence



The Efficiency Proof Point

Intel® Xeon® 5600 Processor

Up to 15x Performance

Up to 95% Energy Reduction

Estimated 5 Month Payback

2 Socket Systems



Intel Xeon 7500 Processor

Up to 20x Performance

Up to 91% Energy Reduction

Estimated 12 Month Payback

2, 4, 8+ Socket Systems

A Good Thing Gets Even Better



Intel® Cloud Builder Program

Open Cirrus™, ETRI, IDA, MIMOS; Universities



Advanced Cloud Research Intel Cloud Test Bed POCs and Joint Labs IT@Intel Case Studies



Building Optimized Clouds Cloud Reference Architectures, Tools and Training



Deployment Best Practices

Industry Partnership NOW to Build the Cloud of the Future Join Us - http://www.intel.com/software/cloudbuilder



Did any consumer product categories do better in 2009 versus 2008?



Hold the beer, wait on the bike but delay the PC purchase?? Never...



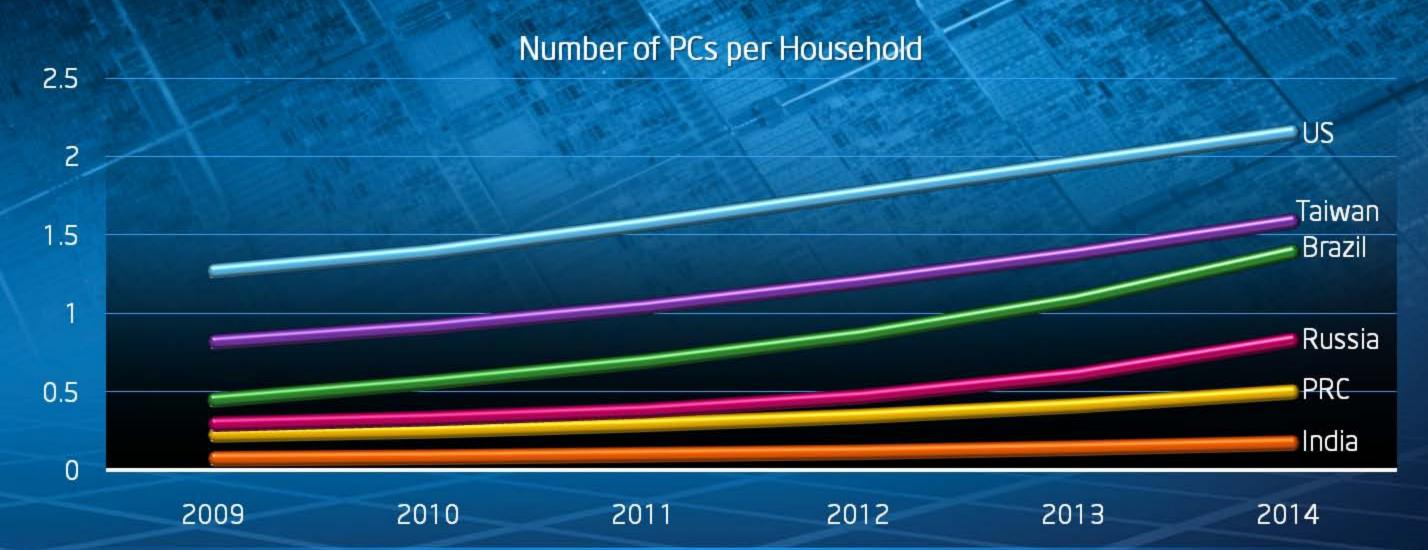




And We'll Double That In 5 Years...



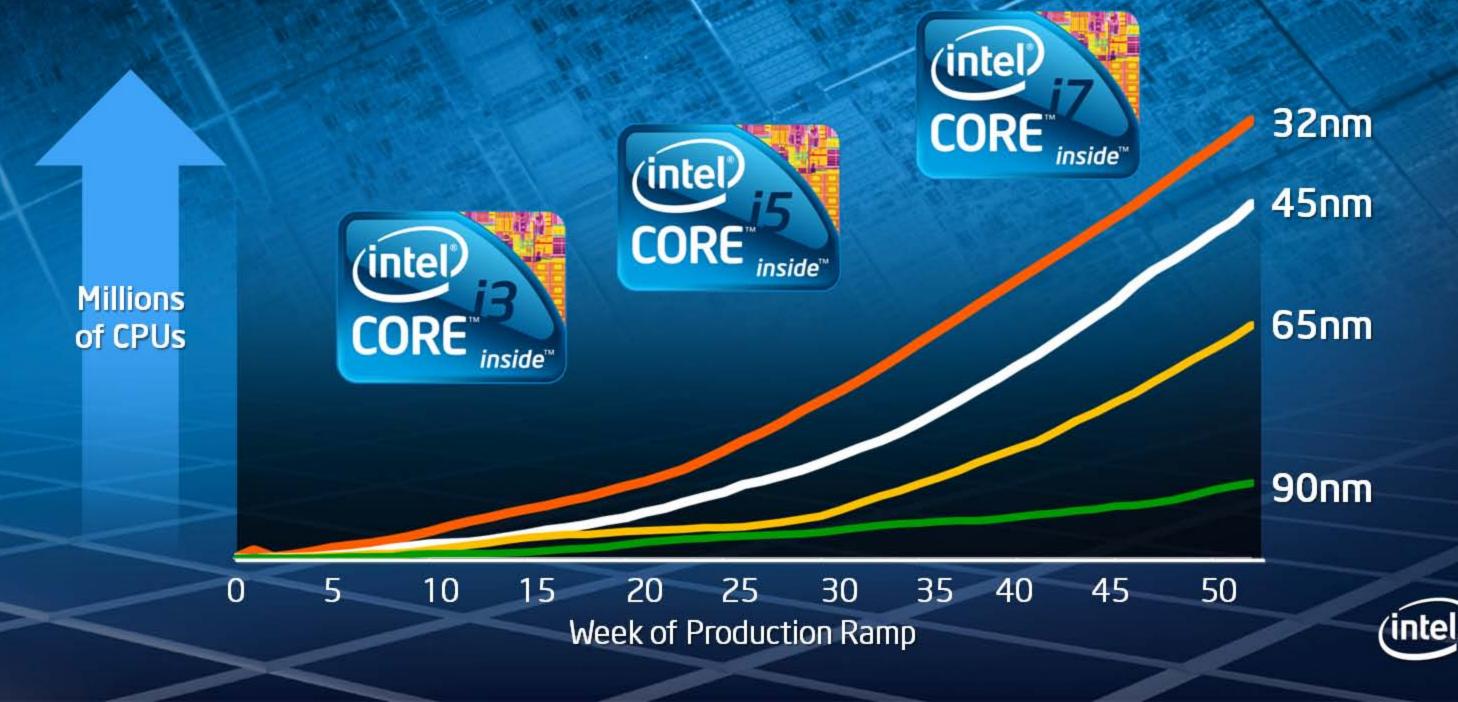
And Plenty of Room for Growth...



~2 Billion People Yet to Own Their "PC Experience"



32nm -> Enabling the Fastest Ramp Ever



A Superior Manufacturing Capability is Critical but So too Are Compelling Usages



Great Media Starts with a Great CPU...

ANANdTECH

"The Perfect Home Theater PC."
January 2010





"Video Playback was perfect and image quality was excellent."

January 2010

...And Ends With A Complete Platform



Coming this Summer

Watch Blu-ray Stereoscopic 3D Movies on PCs Based on 2010 Intel® Core™ Processor with Intel® HD Graphics

Blu-ray stereo 3D for mainstream consumers!

- No extra discrete graphics card needed
- Passive polarized glasses





Intel® Wireless Display We're Just Getting Started...







lenovo



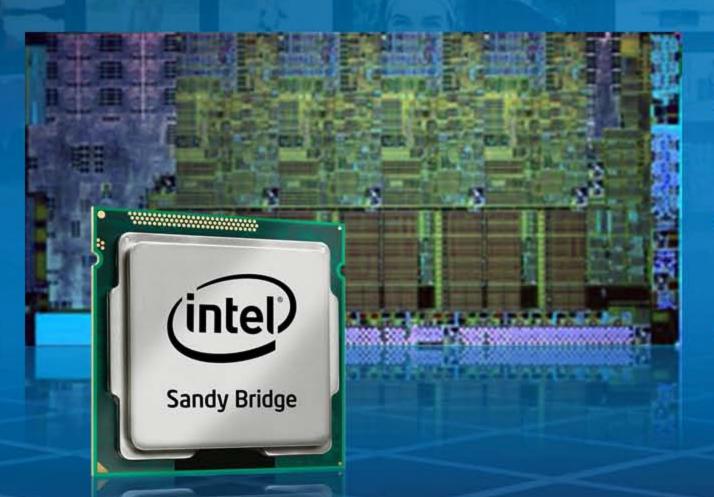
SONY

TOSHIBA
Leading Innovation >>>

Expanding from 3 Designs In the US to Over 30 Worldwide —



The Next Generation Intel® Core™ Processor Code Name Sandy Bridge

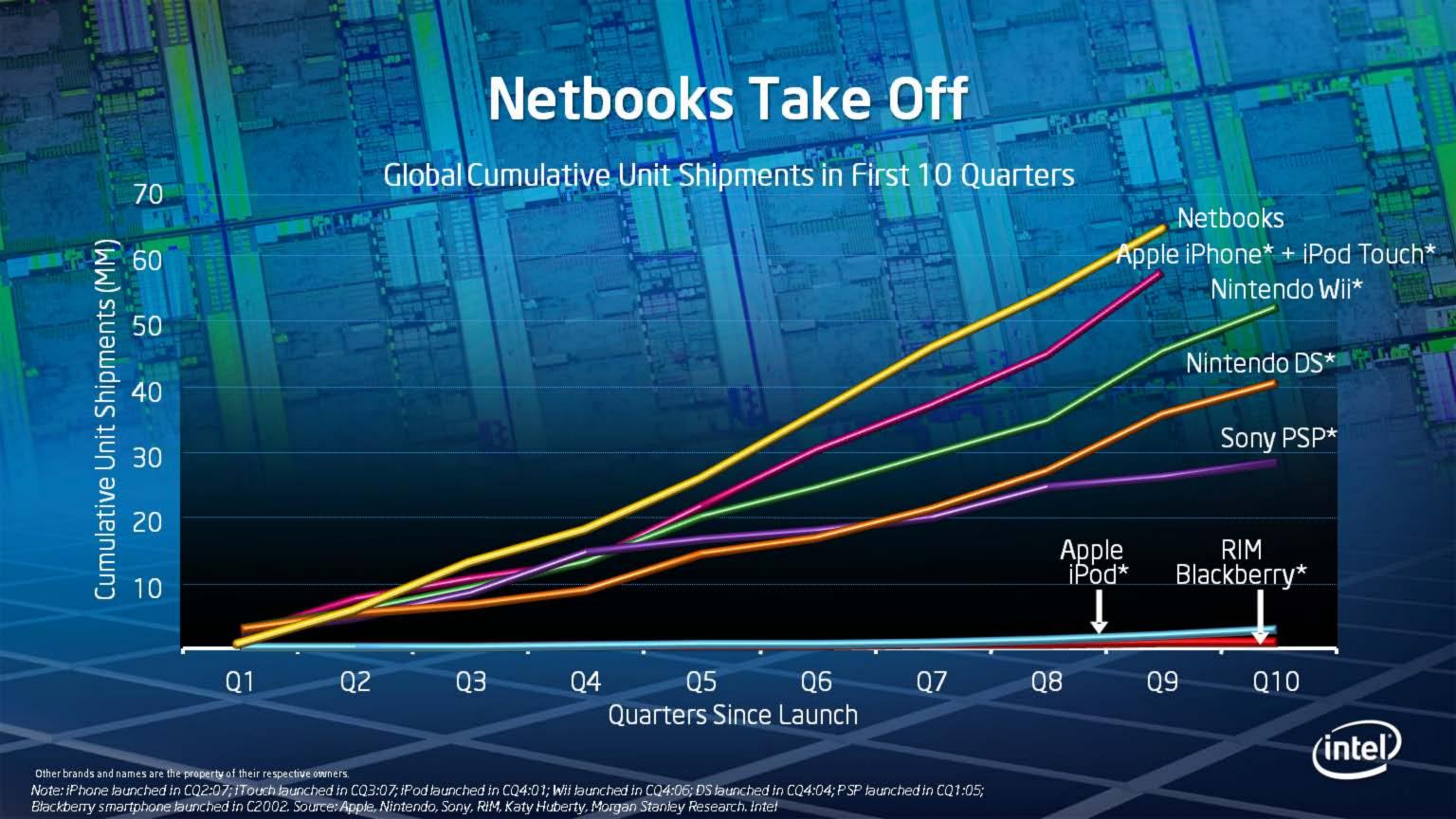


- New 32nm Intel microarchitecture
- Impressive leap in energy-efficient performance
- Significant advances in media and 3D graphics capabilities
- Enhanced overall system performance generation to generation



What category ramped faster than the Blackberry*, iPod* or Nintendo Wii*?



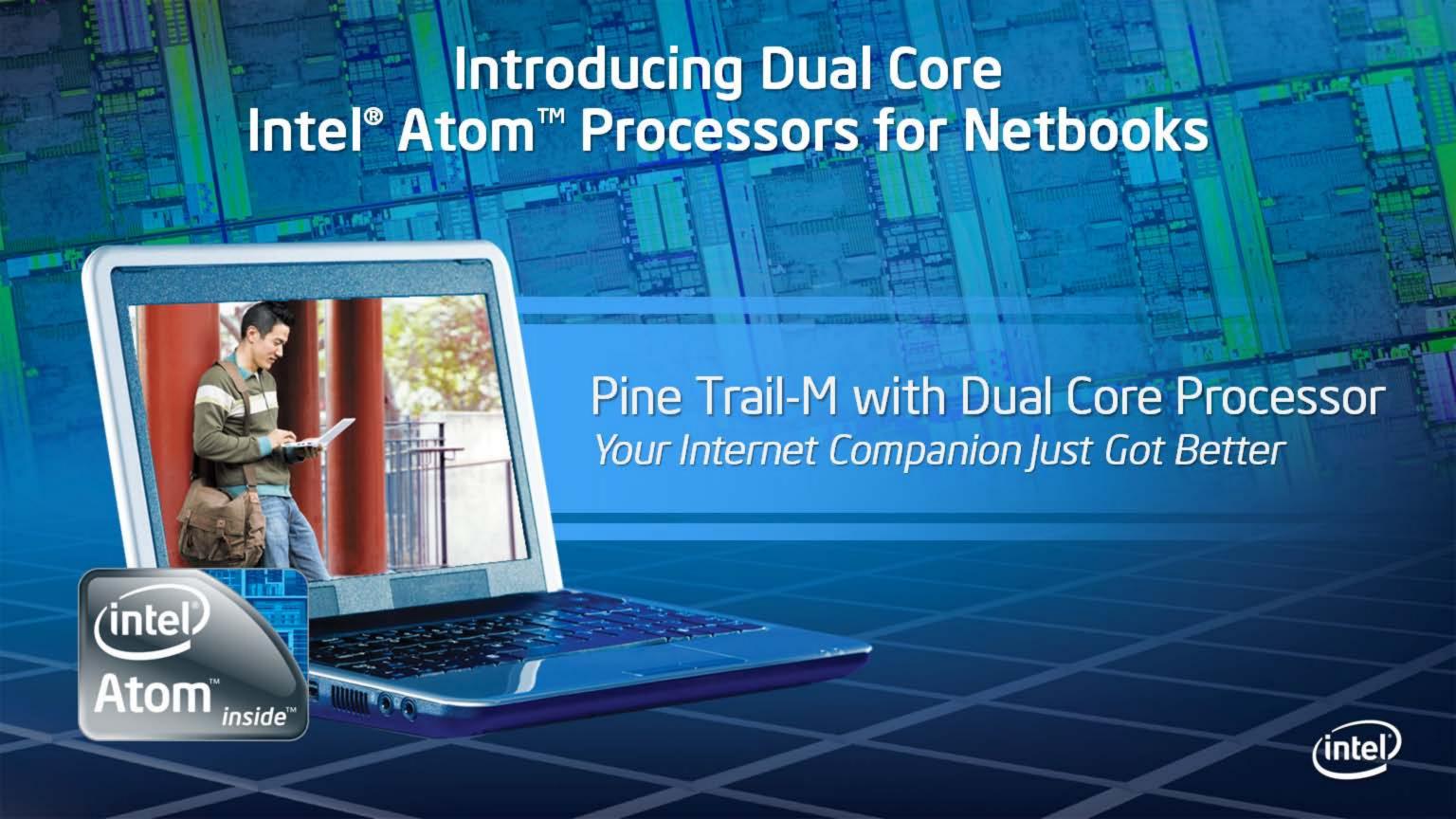


Second Wave of Netbook Innovation

New, exciting form factors

Dual-core performance and DDR3 in a Netbook









Intel® Atom™ is a Family of Solutions

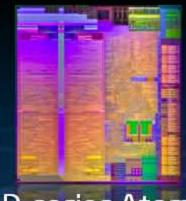


Netbooks



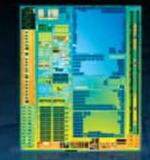
N-series Atom™

Entry Desktops



D-series Atom

Handhelds



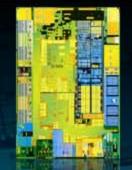
Z-series Atom

Embedded



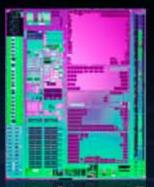
Embedded Series Atom

TV



CE-series Atom

Gadgets



Future Atom SoCs





CE Industry Transitioning to Smart TV





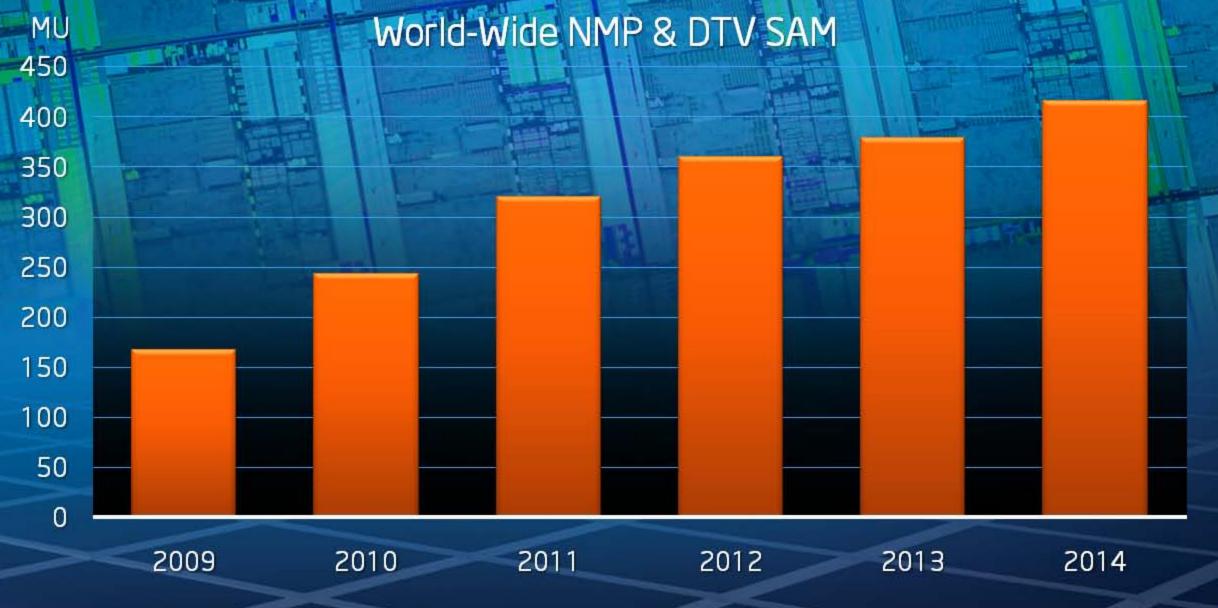


2010+: Smart TV

The Transformation is Underway



Our CE Opportunity is Ramping Faster than Expected!



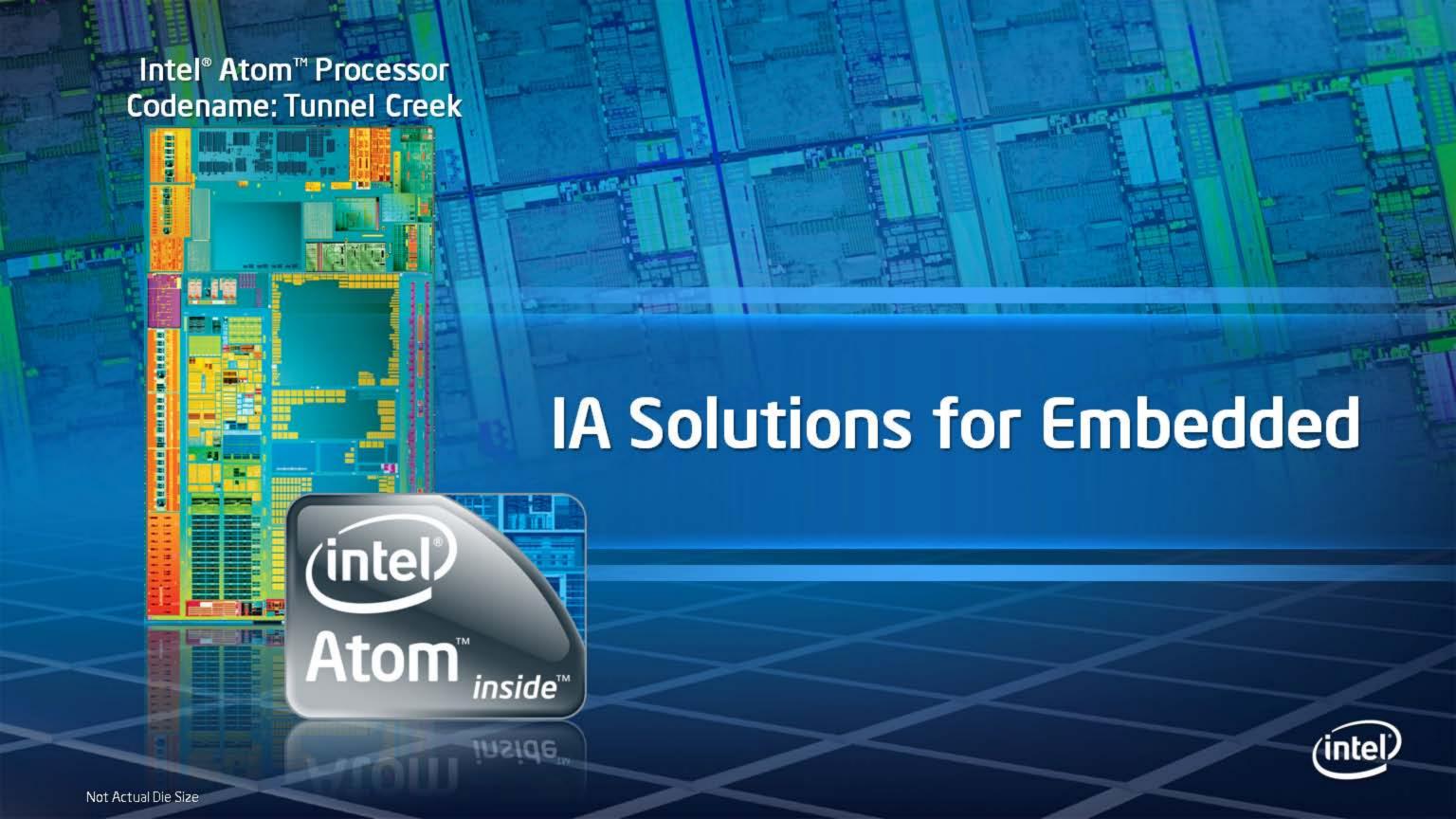


Sources: NMP data taken from ABI, Futursource, In-Stat/ DTV data taken from iSuppli, Display Search

Intel: Delivering a Smart TV Solution







Intel® Atom™ -Embedded Opportunities Everywhere































>3,000 Design Engagements

Biometrics Finger Print Reader
Point of Sale
Digital Weight Scale
ATM

Hotel Concierge System
Handheld Barcode Reader
Handheld Wireless Spectrum Tester
Handheld Ultrasound
Hospital Bedside Terminal
Voting Machine
Lottery Machine
Network Security Appliance
VolP PBX
Test and Measurement Appliance
Education Terminal

Communications Gateway
Programmable Logic Controller
Computer Numeric Controllers
Industrial HMI Panel
Industrial PC

Avionics System

Wearable PC

Connected Soldier Device Military Soldier Training Device

Digital Signage: Transforming Advertising

Entry

Lowest Power
Limited Content Blending



Winmate, Taipei City Zoo

Mainstream

Performance for Analytics Remote Manageability Robust Content Blending



Aopen, Taiwan Carrefour Retail

High End

Highest Performance Remote Manageability Richest Content Blending Large Multi-Display



C-Nario, Shanghai Airport

Harnessing the Full Power of the Continuum





Intel® Atom™ Processor Z6xx Series Making Smartphones Even Smarter...



Range of Form Factors

Smartphones That Fit In Your Shirt Pocket



Uninterrupted Battery Life

>10 Days Standby

>2 Days Music

>5 Hours Video



Fast and Responsive

Multi-tasking

Multi-windowing



Amazing Visual Experience

1080p HD Video Playback

3D Graphics and Gaming



Full Internet Experience

PC-like Internet
Rich and Interactive





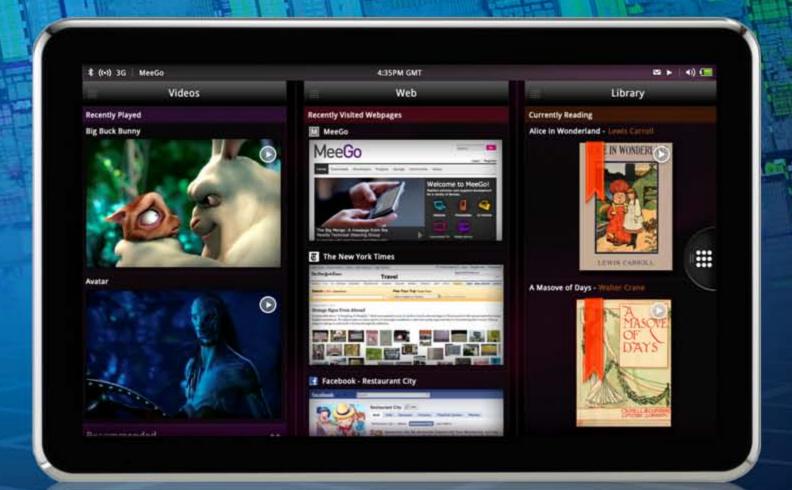
IA Tablet Platform of Choice

Performance Leadership

OS Port of Choice

Open SW Ecosystem

Rich internet Support





Introducing Oak Trail

OS Port of Choice



Google

Rich Media & Graphics

Up to 1080p video decode² & HDMI







Thinner & Innovative Form Factors

Passive cooling
<20mm netbooks
<15mm tablets



Longer Battery Life

50% lower silicon power than Pine Trail Integration of HD video decode & HDMI





4: + Pre-silicon estimate, based on 10.2" display. Win 7, 35Whr battery, power optimized configuration

^{1:} Support for Chrome OS under evaluation 2: Playback performance may vary based on display resolution 3: Based on 3DMarkO6, pre-si estimate 4: Refer to slide 9 for details



Summary

The Compute Continuum Will Fuel the Next 30 Years of Innovation

1 Million PC/Day is An Impressive Feat but We Can Do Much Better!

Intel® Atom™ is Everywhere

But Before I Wrap, There is One More Thing...





Risk Factors

The above statements and any others in this document that refer to plans and expectations for the second quarter, the year and the future are forward-looking statements that involve a number of risks and uncertainties. Many factors could affect Intel's actual results, and variances from Intel's current expectations regarding such factors could cause actual results to differ materially from those expressed in these forward-looking statements. Intel presently considers the following to be the important factors that could cause actual results to differ materially from the corporation's expectations. Demand could be different from Intel's expectations due to factors including changes in business and economic conditions; customer acceptance of Intel's and competitors' products; changes in customer order patterns including order cancellations; and changes in the level of inventory at customers. Intel operates in intensely competitive industries that are characterized by a high percentage of costs that are fixed or difficult to reduce in the short term and product demand that is highly variable and difficult to forecast. Additionally, Intel is in the process of transitioning to its next generation of products on 32nm process technology, and there could be execution issues associated with these changes, including product defects and errata along with lower than anticipated manufacturing yields. Revenue and the gross margin percentage are affected by the timing of new Intel product introductions and the demand for and market acceptance of Intel's products; actions taken by Intel's competitors, including product offerings and introductions, marketing programs and pricing pressures and Intel's response to such actions; defects or disruptions in the supply of materials or resources; and Intel's ability to respond quickly to technological developments and to incorporate new features into its products. The gross margin percentage could vary significantly from expectations based on changes in revenue levels; product mix and pricing; start-up costs, including costs associated with the new 32nm process technology; variations in inventory valuation, including variations related to the timing of qualifying products for sale; excess or obsolete inventory; manufacturing yields; changes in unit costs; impairments of long-lived assets, including manufacturing, assembly/test and intangible assets; the timing and execution of the manufacturing ramp and associated costs; and capacity utilization. Expenses, particularly certain marketing and compensation expenses, as well as restructuring and asset impairment charges, vary depending on the level of demand for Intel's products and the level of revenue and profits. The tax rate expectation is based on current tax law and current expected income. The tax rate may be affected by the jurisdictions in which profits are determined to be earned and taxed; changes in the estimates of credits, benefits and deductions; the resolution of issues arising from tax audits with various tax authorities, including payment of interest and penalties; and the ability to realize deferred tax assets. Gains or losses from equity securities and interest and other could vary from expectations depending on gains or losses realized on the sale or exchange of securities; gains or losses from equity method investments; impairment charges related to debt securities as well as equity and other investments; interest rates; cash balances; and changes in fair value of derivative instruments. The majority of our non-marketable equity investment portfolio balance is concentrated in the flash memory market segment, and declines in this market segment or changes in management's plans with respect to our investment in this market segment could result in significant impairment charges, impacting restructuring charges as well as gains /losses on equity investments and interest and other. Intel's results could be impacted by adverse economic, social, political and physical/infrastructure conditions in countries where Intel, its customers or its suppliers operate, including military conflict and other security risks, natural disasters, infrastructure disruptions, health concerns and fluctuations in currency exchange rates. Intel's results could be affected by the timing of closing of acquisitions and divestitures. Intel's results could be affected by adverse effects associated with product defects and errata (deviations from published specifications), and by litigation or regulatory matters involving intellectual property, stockholder, consumer, antitrust and other issues, such as the litigation and regulatory matters described in Intel's SEC reports. An unfavorable ruling could include monetary damages or an injunction prohibiting us from manufacturing or selling one or more products, precluding particular business practices, impacting our ability to design our products, or requiring other remedies such as compulsory licensing of intellectual property. A detailed discussion of these and other factors that could affect Intel's results is included in Intel's SEC filings, including the report on Form 10-Q for the guarter ended March 27, 2010.



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